Quad Analog Switch/ Multiplexer/Demultiplexer with LSTTL Compatible Inputs

High-Performance Silicon-Gate CMOS

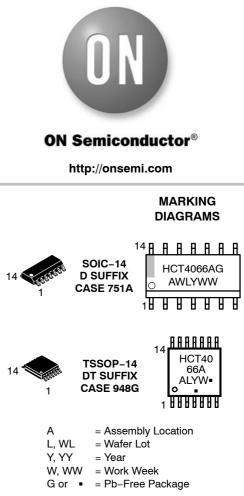
The MC74HCT4066A utilizes silicon-gate CMOS technology to achieve fast propagation delays, low ON resistances, and low OFF-channel leakage current. This bilateral switch/multiplexer/demultiplexer controls analog and digital voltages that may vary across the full power-supply range (from V_{CC} to GND).

The HCT4066A is identical in pinout to the metal–gate CMOS MC14016 and MC14066. Each device has four independent switches. The device has been designed so the ON resistances (R_{ON}) are more linear over input voltage than R_{ON} of metal–gate CMOS analog switches.

The ON/OFF control inputs are compatible with standard CMOS and LSTTL outputs. For analog switches with voltage–level translators, see the HC4316A.

Features

- Fast Switching and Propagation Speeds
- High ON/OFF Output Voltage Ratio
- Low Crosstalk Between Switches
- Diode Protection on All Inputs/Outputs
- Wide Power–Supply Voltage Range (V_{CC} GND) = 4.5 to 5.5 V
- Analog Input Voltage Range ($V_{CC} GND$) = 0 to 5.5 V
- Improved Linearity and Lower ON Resistance over Input Voltage than the MC14016 or MC14066
- Low Noise
- Chip Complexity: 44 FETs or 11 Equivalent Gates
- These are Pb-Free Devices



(Note: Microdot may be in either location)

ORDERING INFORMATION

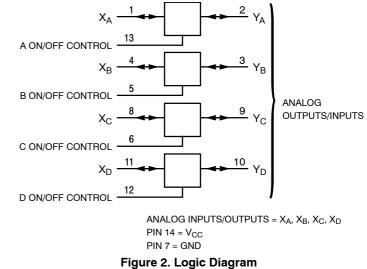
See detailed ordering and shipping information in the package dimensions section on page 2 of this data sheet.

× _A d	1•	14	vcc
Y _A [2	13	A ON/OFF CONTROL
Y _B [3	12] D ON/OFF CONTROL
Х _В [4	11	D x _D
B ON/OFF CONTROL	5	10] Y _D
C ON/OFF CONTROL	6	9	ΓY _C
GND C	7	8	D x _c
ı			1

Figure 1. Pin Assignment

FUNCTION TABLE

On/Off Control Input	State of Analog Switch
L	Off
Н	On



ORDERING INFORMATION

Device	Package	Shipping [†]
MC74HCT4066ADG	SOIC-14 (Pb-Free)	55 Units / Rail
MC74HCT4066ADR2G	SOIC-14 (Pb-Free)	2500 / Tape & Reel
MC74HCT4066ADTR2G	TSSOP-14*	2500 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

*This package is inherently Pb-Free.

MAXIMUM RATINGS

Symbol	Paramete	Value	Unit	
V _{CC}	Positive DC Supply Voltage (Re	-0.5 to +14.0	V	
VIS	Analog Input Voltage (Reference	-0.5 to V _{CC} + 0.5	V	
V _{in}	Digital Input Voltage (Reference	-0.5 to V _{CC} + 0.5	V	
I	DC Current Into or Out of Any P	±25	mA	
P _D	Power Dissipation in Still Air,	SOIC Package† TSSOP Package†	500 450	mW
T _{stg}	Storage Temperature		–65 to +150	°C

This device contains protection circuitry to guard against damage due to high static voltages or electric fields. However, precautions must be taken to avoid applications of any voltage higher than maximum rated voltages to this high-impedance circuit. For proper operation, V_{in} and V_{out} should be constrained to the range GND \leq (V_{in} or V_{out}) \leq V_{CC} .

Unused inputs must always be tied to an appropriate logic voltage level (e.g., either GND or V_{CC}). Unused outputs must be left open. I/O pins must be connected to a properly terminated line or bus.

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

†Derating – SOIC Package: – 7 mW/°C from 65°C to 125°C TSSOP Package: – 6.1 mW/°C from 65°C to 125°C

RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter		Min	Мах	Unit
V _{CC}	Positive DC Supply Voltage (Referenced to GND)		4.5	5.5	V
VIS	Analog Input Voltage (Referenced to GND)		GND	V _{CC}	V
V _{in}	Digital Input Voltage (Referenced to GND)		GND	V _{CC}	V
V _{IO} *	Static or Dynamic Voltage Across Switch		-	1.2	V
T _A	Operating Temperature, All Package Types		-55	+125	°C
t _r , t _f	Input Rise and Fall Time, ON/OFF Control Inputs (Figure 10)	V _{CC} = 4.5 V	0	500	ns

*For voltage drops across the switch greater than 1.2 V (switch on), excessive V_{CC} current may be drawn; i.e., the current out of the switch may contain both V_{CC} and switch input components. The reliability of the device will be unaffected unless the Maximum Ratings are exceeded.

DC ELECTRICAL CHARACTERISTIC Digital Section (Voltages Referenced to GND)

				Gu	aranteed Li	mit	
Symbol	Parameter	Test Conditions	V _{CC} V	– 55 to 25°C	≤ 85 °C	≤ 125°C	Unit
V _{IH}	Minimum High-Level Voltage ON/OFF Control Inputs	R _{on} = Per Spec	4.5 to 5.5	2.0	2.0	2.0	V
V_{IL}	Maximum Low-Level Voltage ON/OFF Control Inputs	R _{on} = Per Spec	4.5 to 5.5	0.8	0.8	0.8	V
l _{in}	Maximum Input Leakage Current ON/OFF Control Inputs	V _{in} = V _{CC} or GND	5.5	±0.1	±1.0	±1.0	μA
ICC	Maximum Quiescent Supply Current (per Package)	$V_{in} = V_{CC}$ or GND $V_{IO} = 0 V$	5.5	2	20	40	μA
ΔI_{CC}	Additional Quiescent Supply Current (per Input)	$V_{in} = V_{CC} - 2.1 V$ Other control inputs at V_{CC} or GND	4.5 to 5.5	360	450	490	μA

DC ELECTRICAL CHARACTERISTICS Analog Section (Voltages Referenced to GND)

				Gu	aranteed Li	mit	
Symbol	Parameter	Test Conditions	v _{cc} v	– 55 to 25°C	≤ 85°C	≤ 125°C	Unit
R _{on}	Maximum "ON" Resistance	$ \begin{array}{l} V_{in} = V_{IH} \\ V_{IS} = V_{CC} \text{ to GND} \\ I_S \leq 2.0 \text{ mA (Figures 3, 4)} \end{array} $	4.5	120	160	200	Ω
		$ \begin{array}{l} V_{in} = V_{IH} \\ V_{IS} = V_{CC} \text{ or GND} \\ (Endpoints) \\ I_{S} \leq 2.0 \text{ mA (Figures 3, 4)} \end{array} $	4.5	70	85	120	
ΔR _{on}	Maximum Difference in "ON" Resistance Between Any Two Channels in the Same Package	$\label{eq:Vin} \begin{array}{l} V_{in} = V_{IH} \\ V_{IS} = 1/2 \; (V_{CC} - GND) \\ I_S \leq 2.0 \; \text{mA} \end{array}$	4.5	20	25	30	Ω
l _{off}	Maximum Off-Channel Leakage Current, Any One Channel	$V_{in} = V_{IL}$ $V_{IO} = V_{CC}$ or GND Switch Off (Figure 5)	5.5	0.1	0.5	1.0	μΑ
I _{on}	Maximum On-Channel Leakage Current, Any One Channel		5.5	0.1	0.5	1.0	μΑ

AC ELECTRICAL CHARACTERISTICS (CL = 50 pF, ON/OFF Control Inputs: $t_r = t_f = 6 \text{ ns}$)

			Guaranteed Limit		mit		
Symbol	Parameter		v _{cc} v	– 55 to 25°C	≤ 85 °C	≤ 125°C	Unit
t _{PLH} , t _{PHL}	Maximum Propagation Delay, Analog Inpu (Figures 10 and 11)	it to Analog Output	4.5	10	13	15	ns
t _{PLZ} , t _{PHZ}	Maximum Propagation Delay, ON/OFF Control to Analog Output (Figures 12 and 13)		4.5	30	38	45	ns
t _{PZL} , t _{PZH}	Maximum Propagation Delay, ON/OFF Control to Analog Output (Figures 12 and 13)		4.5	25	32	37	ns
С	Maximum Capacitance	ON/OFF Control Input	_	10	10	10	pF
		Control Input = GND					
		Analog I/O	-	35	35	35	
		Feedthrough	-	1.0	1.0	1.0	

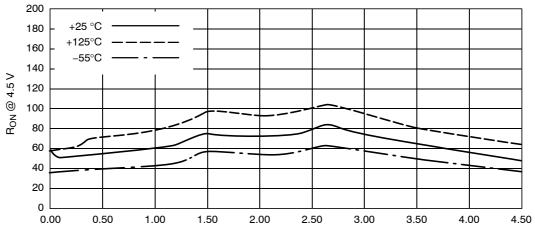
	Typical @ 25°C, V _{CC} = 5.0 V	
C _{PD} Power Dissipation Capacitance (Per Switch) (Figure 15)*	15	pF

*Used to determine the no–load dynamic power consumption: P_D = C_{PD} V_{CC}^2 f + I_{CC} V_{CC}.

ADDITIONAL APPLICATION CHARACTERISTICS (Voltages Referenced to GND Unless Noted)

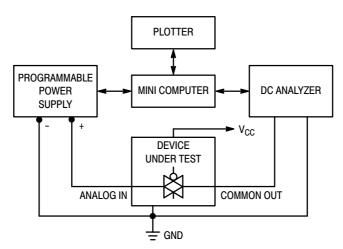
Symbol	Parameter	Test Conditions	V _{CC} V	Limit* 25°C 54/74HCT	Unit
BW	Maximum On–Channel Bandwidth or Minimum Frequency Response (Figure 7)	$f_{in} = 1 \text{ MHz}$ Sine Wave Adjust f_{in} Voltage to Obtain 0 dBm at V _{OS} Increase f_{in} Frequency Until dB Meter Reads – 3 dB Bi = 50 Ω , C ₁ = 10 pF	4.5	150	MHz
_	Off-Channel Feedthrough Isolation (Figure 8)	$f_{in} \equiv$ Sine Wave Adjust f_{in} Voltage to Obtain 0 dBm at V _{IS} $f_{in} = 10$ kHz, R _L = 600 Ω , C _L = 50 pF	4.5	-50	dB
		f_{in} = 1.0 MHz, R _L = 50 Ω, C _L = 10 pF	4.5	-40	
-	Feedthrough Noise, Control to Switch (Figure 9)	$\label{eq:Vin} \begin{array}{l} V_{in} \leq 1 \text{ MHz Square Wave } (t_r = t_f = 6 \text{ ns}) \\ \text{Adjust } R_L \text{ at Setup so that } I_S = 0 \text{ A} \\ R_L = 600 \ \Omega, \ C_L = 50 \text{ pF} \end{array}$	4.5	60	mV _{PP}
		R _L = 10 kΩ, C _L = 10 pF	4.5	30	
_	Crosstalk Between Any Two Switches	$f_{in} \equiv$ Sine Wave Adjust f_{in} Voltage to Obtain 0 dBm at V_{IS}			dB
	(Figure 14)	f _{in} = 10 kHz, R _L = 600 Ω, C _L = 50 pF f _{in} = 1.0 MHz, R _I = 50 Ω, C _L = 10 pF	4.5	-70 -80	
THD	Total Harmonic Distortion (Figure 16)	$f_{in} = 1 \text{ kHz}, R_L = 10 \text{ k}\Omega, C_L = 50 \text{ pF}$ THD = THD _{Measured} – THD _{Source}	4.0		%
		$V_{IS} = 4.0 V_{PP}$ sine wave	4.5	0.10	

*Guaranteed limits not tested. Determined by design and verified by qualification.

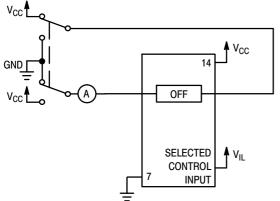


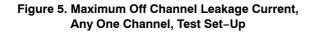
V_{is}, INPUT VOLTAGE (VOLTS), REFERENCED TO GROUND

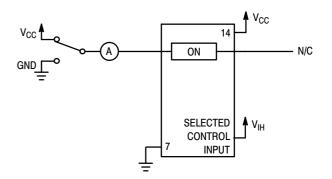


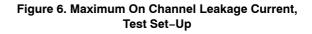


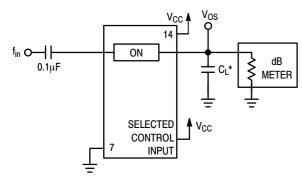






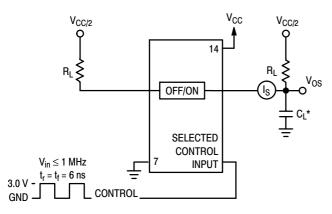


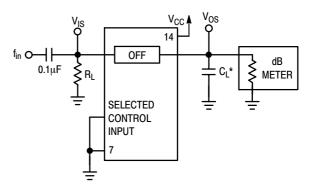




*Includes all probe and jig capacitance.

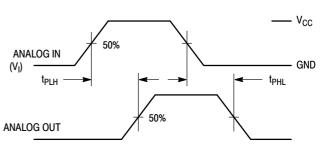
Figure 7. Maximum On–Channel Bandwidth Test Set–Up





*Includes all probe and jig capacitance.

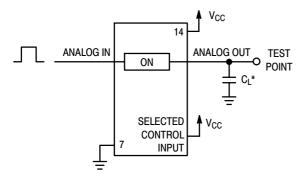
Figure 8. Off–Channel Feedthrough Isolation, Test Set–Up



*Includes all probe and jig capacitance.

Figure 9. Feedthrough Noise, ON/OFF Control to Analog Out, Test Set–Up

Figure 10. Propagation Delays, Analog In to Analog Out



*Includes all probe and jig capacitance.

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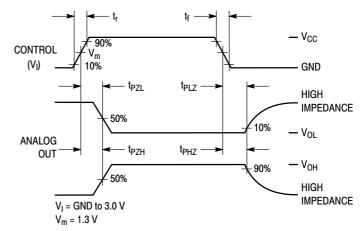
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V_{CC}

Figure 11. Propagation Delay Test Set-Up





ON

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OFF

SELECTED

CONTROL

INPUT

V_{CC}

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CL*

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δ

V_{CC/2}

C_L*

 R_L

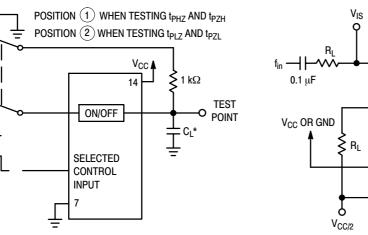
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9

V_{CC/2}

 R_L



*Includes all probe and jig capacitance.

Figure 13. Propagation Delay Test Set-Up

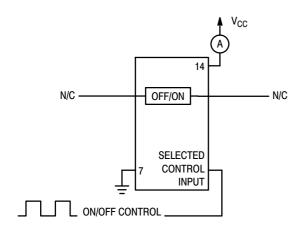
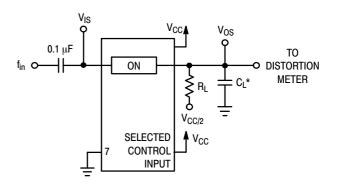


Figure 15. Power Dissipation Capacitance Test Set–Up

*Includes all probe and jig capacitance.

Figure 14. Crosstalk Between Any Two Switches, Test Set–Up



*Includes all probe and jig capacitance.

Figure 16. Total Harmonic Distortion, Test Set-Up

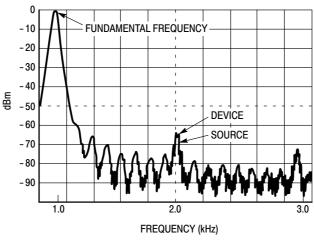


Figure 17. Plot, Harmonic Distortion

APPLICATION INFORMATION

Unused analog inputs/outputs may be left floating (not connected). However, it is advisable to tie unused analog inputs and outputs to $V_{\rm CC}$ or GND through a low value resistor. This minimizes crosstalk and feedthrough noise that may be picked–up by the unused I/O pins.

The maximum analog voltage swings are determined by the supply voltages V_{CC} and GND. The positive peak analog voltage should not exceed V_{CC} . Similarly, the negative peak analog voltage should not go below GND. In the example below, the difference between V_{CC} and GND is twelve volts. Therefore, using the configuration in Figure 16, a maximum analog signal of twelve volts peak-to-peak can be controlled.

When voltage transients above V_{CC} and/or below GND are anticipated on the analog channels, external diodes (Dx) are recommended as shown in Figure 17. These diodes should be small signal, fast turn-on types able to absorb the maximum anticipated current surges during clipping. An alternate method would be to replace the Dx diodes with MOSORB® (MOSORB is an acronym for high current surge protectors). MOSORBs are fast turn-on devices ideally suited for precise DC protection with no inherent wear out mechanism.

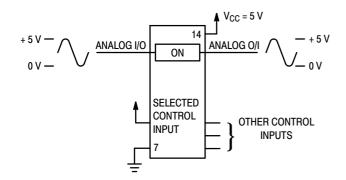


Figure 18. 5 V Application

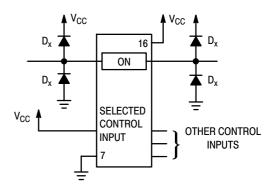


Figure 19. Transient Suppressor Application

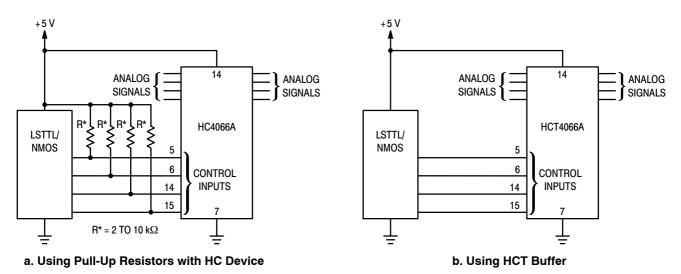
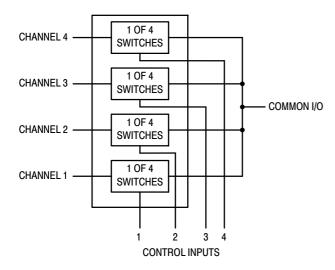


Figure 20. LSTTL/NMOS to HCTMOS Interface





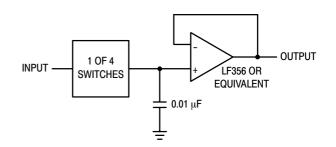
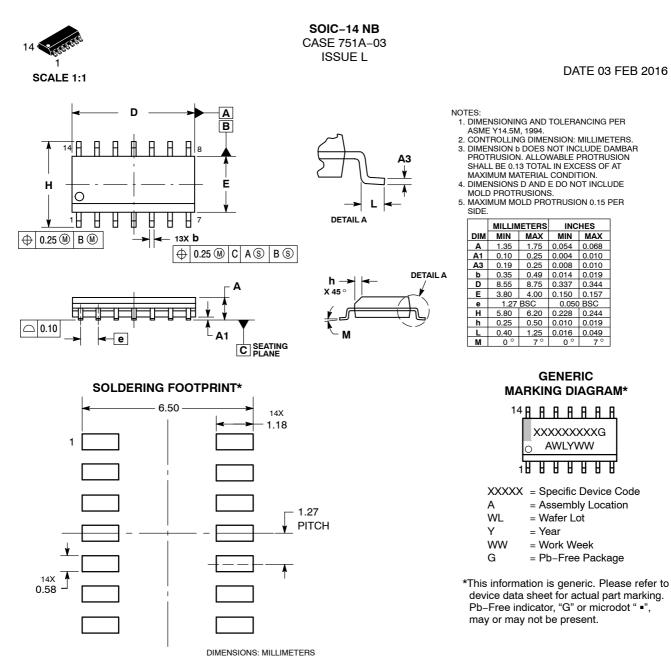


Figure 22. Sample/Hold Amplifier





*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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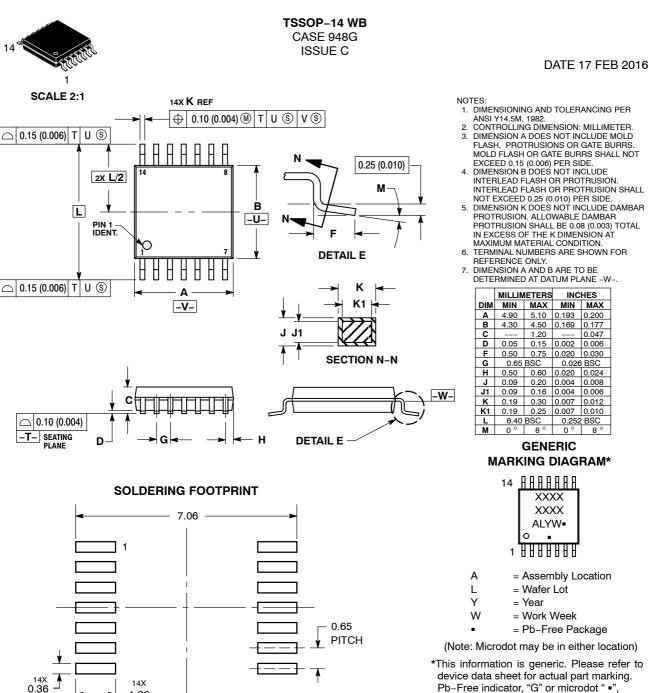
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